

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2868785

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PING-YU CHEN	10/18/2013
JIE-WEI LAI	10/18/2013
SEAN T. NICOLSON	10/18/2013
MING-DA TSAI	10/18/2013
JING-HONG C. ZHAN	10/18/2013
RECEIVING PARTY DATA	
Name:	MEDIATEK, INC.
Street Address:	NO. 1 DUSING ROAD. 1ST
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU 300, R.O.C.
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14136898
CORRESPONDENCE DATA	
Fax Number:	(631)844-0081
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	6318440080
Email:	rebecca@tb-iplaw.com
Correspondent Name:	TUTUNJIAN & BITETTO, P.C.
Address Line 1:	425 BROADHOLLOW ROAD
Address Line 2:	SUITE 302
Address Line 4:	MELVILLE, NEW YORK 11747
ATTORNEY DOCKET NUMBER:	YOR920090367US3 (328 DIV)
NAME OF SUBMITTER:	JAMES J. BITETTO
SIGNATURE:	/jjb/
DATE SIGNED:	05/23/2014
Total Attachments: 6	
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DOCKET NUMBER: YOR920090367US3 (163-328 DIV))

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: **PHASED-ARRAY TRANSCEIVER FOR MILLIMETER-WAVE FREQUENCIES**

and further identified by the Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Serial Number: 14/136,898 (insert series code and serial number here if/when available)

Whereas, MediaTek, Inc., a Taiwan corporation, located at No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C. (herein referred to as "MediaTek"), desires to acquire, and each undersigned Inventor desires to grant to _____, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to MediaTek (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to MediaTek, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by MediaTek, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in MediaTek, its successors, legal representatives, and assigns, whenever requested by MediaTek, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to MediaTek and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants MediaTek, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Pages Follow]

Executed by Inventor 1 of 5

Signature: Ping-Yu Chen Date: 2013.10.18
(Ping-Yu Chen)

DOCKET NUMBER: YOR920090367US3 (163-328 DIV))

Executed by Inventor 2 of 5

Signature: _____

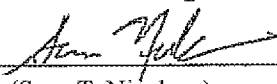

(Jie-Wei Lai)

Date: _____

2013.10.18

Executed by Inventor 3 of 5

Signature: _____



(Sean T. Nicolson)

Date: _____

2013.10.18

DOCKET NUMBER: YOR920090367US3 (163-328 DIV))

Executed by Inventor 4 of 5

Signature: _____

(Ming-Da Tsai)

Ming-Da Tsai

Date: _____

2013.10.18

Executed by Inventor 5 of 5

Signature: _____

(Jing-Hong C. Zhan)

Date: _____

2013.10.18